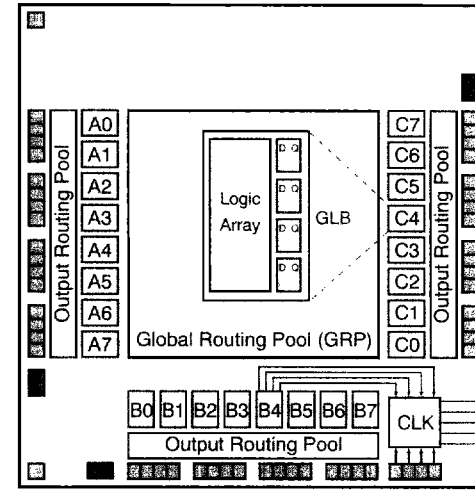
ispLSI® 1024

High Density Programmable Logic

Features

- **HIGH DENSITY PROGRAMMABLE LOGIC**
  - **— High-Speed Global Interconnect**
  - **— 4000 PLD Gates**
  - **— 48 I/O Pins, Six Dedicated Inputs**
  - **— 144 Registers**
  - **— Wide Input Gating for Fast Counters, State Machines, Address Decoders, etc.**
  - **— Small Logic Block Size for Fast Random Logic**
  - **— Security Cell Prevents Unauthorized Copying**
- **HIGH PERFORMANCE E²CMOS® TECHNOLOGY**
  - **— fmax = 90 MHz Maximum Operating Frequency**
  - **— fmax = 60 MHz for Industrial and Military/883 Devices**
  - **— tpd = 12 ns Propagation Delay**
  - **— TTL Compatible Inputs and Outputs**
  - **— Electrically Erasable and Reprogrammable**
  - **— Non-Volatile E²CMOS Technology**
  - **— 100% Tested**
- **ispLSI OFFERS THE FOLLOWING ADDED FEATURES**
  - **— In-System Programmable™ (ISP™) 5-Volt Only**
  - **— Increased Manufacturing Yields, Reduced Time-to-Market, and Improved Product Quality**
  - **— Reprogram Soldered Devices for Faster Debugging**
- **COMBINES EASE OF USE AND THE FAST SYSTEM SPEED OF PLDs WITH THE DENSITY AND FLEXIBILITY OF FIELD PROGRAMMABLE GATE ARRAYS**
  - **— Complete Programmable Device Can Combine Glue Logic and Structured Designs**
  - **— Four Dedicated Clock Input Pins**
  - **— Synchronous and Asynchronous Clocks**
  - **— Flexible Pin Placement**
  - **— Optimized Global Routing Pool Provides Global Interconnectivity**
- **ispEXPERT™ – LOGIC COMPILER AND COMPLETE ISP DEVICE DESIGN SYSTEMS FROM HDL SYNTHESIS THROUGH IN-SYSTEM PROGRAMMING**
  - **— Superior Quality of Results**
  - **— Tightly Integrated with Leading CAE Vendor Tools**
  - **— Productivity Enhancing Timing Analyzer, Explore Tools, Timing Simulator and ispANALYZER™**
  - **— PC and UNIX Platforms**

Functional Block Diagram



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Description

The ispLSI 1024 is a High Density Programmable Logic Devices containing 144 Registers, 48 Universal I/O pins, six Dedicated Input pins, four Dedicated Clock Input pins and a Global Routing Pool (GRP). The GRP provides complete interconnectivity between all of these elements. The ispLSI 1024 features 5V in-system programmability and in-system diagnostic capabilities. It is the first device which offers non-volatile reprogrammability of the logic, as well as the interconnect to provide truly reconfigurable systems.

The basic unit of logic on the ispLSI 1024 device is the Generic Logic Block (GLB). The GLBs are labeled A0, A1 .. C7 (see Figure 1). There are a total of 24 GLBs in the ispLSI 1024 device. Each GLB has 18 inputs, a programmable AND/OR/XOR array, and four outputs which can be configured to be either combinatorial or registered. Inputs to the GLB come from the GRP and dedicated inputs. All of the GLB outputs are brought back into the GRP so that they can be connected to the inputs of any other GLB on the device.

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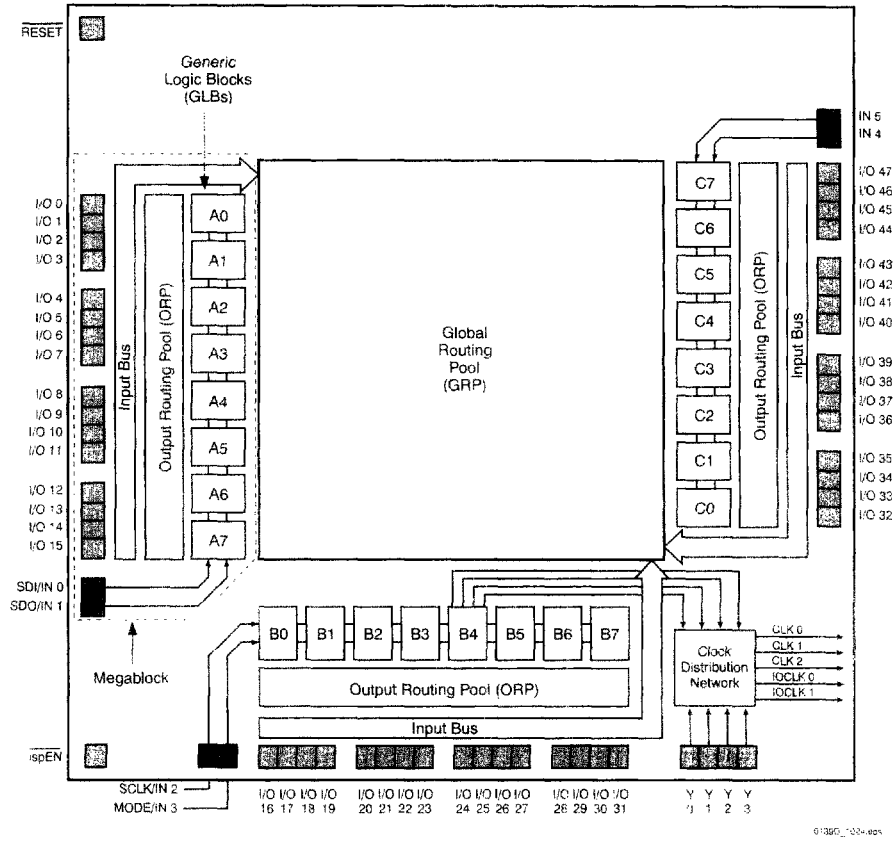
Functional Block Diagram

Figure 1. ispLSI 1024 Functional Block Diagram



The device also has 48 I/O cells, each of which is directly connected to an I/O pin. Each I/O cell can be individually programmed to be a combinatorial input, registered input, latched input, output or bi-directional I/O pin with 3-state control. Additionally, all outputs are polarity selectable, active high or active low. The signal levels are TTL compatible voltages and the output drivers can source 4 mA or sink 8 mA.

Eight GLBs, 16 I/O cells, two dedicated inputs and one ORP are connected together to make a Megablock (see Figure 1). The outputs of the eight GLBs are connected to a set of 16 universal I/O cells by the ORP. The I/O cells within the Megablock also share a common Output Enable (OE) signal. The ispLSI 1024 device contains three of these Megablocks.

The GRP has as its inputs the outputs from all of the GLBs and all of the inputs from the bi-directional I/O cells. All of these signals are made available to the inputs of the GLBs. Delays through the GRP have been equalized to minimize timing skew.

Clocks in the ispLSI 1024 device are selected using the Clock Distribution Network. Four dedicated clock pins (Y0, Y1, Y2 and Y3) are brought into the distribution network, and five clock outputs (CLK 0, CLK 1, CLK 2, IOCLK 0 and IOCLK 1) are provided to route clocks to the GLBs and I/O cells. The Clock Distribution Network can also be driven from a special clock GLB (B4 on the ispLSI 1024 device). The logic of this GLB allows the user to create an internal clock from a combination of internal signals within the device.

External Timing Parameters

Over Recommended Operating Conditions

PARAMETER	TEST COND.[5]	#[2]	DESCRIPTION[1]	-90		-80		-60		UNITS
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t_{pd1}	A	1	Data Propagation Delay, 4PT bypass, ORP bypass	–	12	–	15	–	20	ns
t_{pd2}	A	2	Data Propagation Delay, Worst Case Path	–	17	–	20	–	25	ns
f_{max} (Int.)	A	3	Clock Frequency with Internal Feedback[3]	90.9	–	80	–	60	–	MHz
f_{max} (Ext.)	–	4	Clock Frequency with External Feedback $\left(\frac{1}{t_{su2} + t_{co1}}\right)$	58.8	–	50	–	38	–	MHz
f_{max} (Tog.)	–	5	Clock Frequency, Max Toggle[4]	125	–	100	–	83	–	MHz
t_{su1}	–	6	GLB Reg. Setup Time before Clock, 4PT bypass	6	–	7	–	9	–	ns
t_{co1}	A	7	GLB Reg. Clock to Output Delay, ORP bypass	–	8	–	10	–	13	ns
t_{h1}	–	8	GLB Reg. Hold Time after Clock, 4 PT bypass	0	–	0	–	0	–	ns
t_{su2}	–	9	GLB Reg. Setup Time before Clock	9	–	10	–	13	–	ns
t_{co2}	–	10	GLB Reg. Clock to Output Delay	–	10	–	12	–	16	ns
t_{h2}	–	11	GLB Reg. Hold Time after Clock	0	–	0	–	0	–	ns
t_{r1}	A	12	Ext. Reset Pin to Output Delay	–	15	–	17	–	22.5	ns
t_{rw1}	–	13	Ext. Reset Pulse Duration	10	–	10	–	13	–	ns
t_{en}	B	14	Input to Output Enable	–	15	–	18	–	24	ns
t_{dis}	C	15	Input to Output Disable	–	15	–	18	–	24	ns
t_{wh}	–	16	Ext. Sync. Clock Pulse Duration, High	4	–	5	–	6	–	ns
t_{wl}	–	17	Ext. Sync. Clock Pulse Duration, Low	4	–	5	–	6	–	ns
t_{su5}	–	18	I/O Reg. Setup Time before Ext. Sync. Clock (Y2, Y3)	2	–	2	–	2.5	–	ns
t_{h5}	–	19	I/O Reg. Hold Time after Ext. Sync. Clock (Y2, Y3)	6.5	–	6.5	–	8.5	–	ns

Table 2-0030-24/90,80,60

1. Unless noted otherwise, all parameters use a GRP load of 4 GLBs, 20 PTXOR path, ORP and Y0 clock.
2. Refer to Timing Model in this data sheet for further details.
3. Standard 16-Bit loadable counter using GRP feedback.
4. fmax (Toggle) may be less than 1/(twh + twl). This is to allow for a clock duty cycle of other than 50%.
5. Reference Switching Test Conditions Section.